

Nb₃Sn diffusion and grain growth behavior

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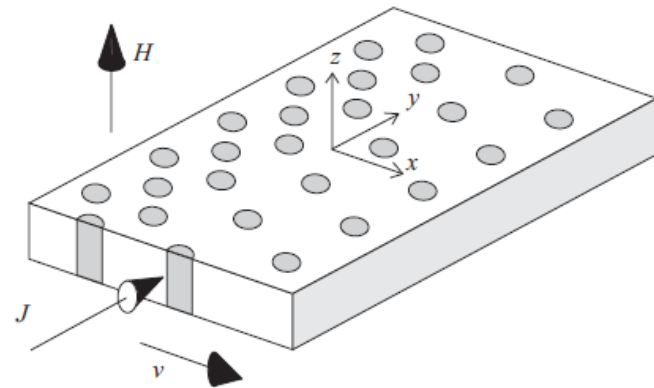
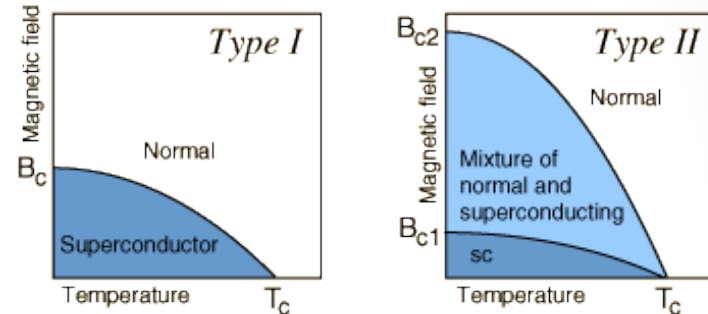
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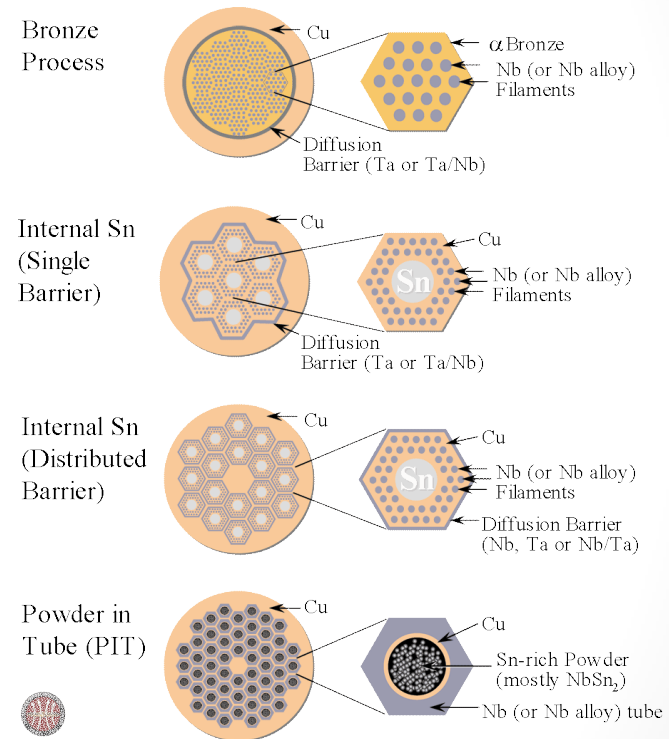
Introduction

- Nb_3Sn is a **type-2 superconductor**: when the magnetic field is higher than H_{c1} , **magnetic vortex pass through** the material, turning a region from superconductive to **normal**.
- Vortex feel the presence of the field generated from the **supercurrent**, and tend to **migrate** in the lower density region.
- To do not loose the superconductive state they must be **pinned** by material defects, like **grain boundaries**



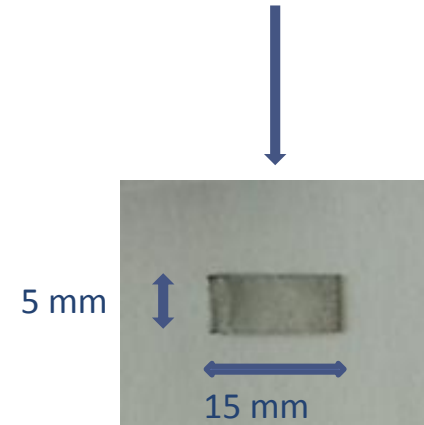
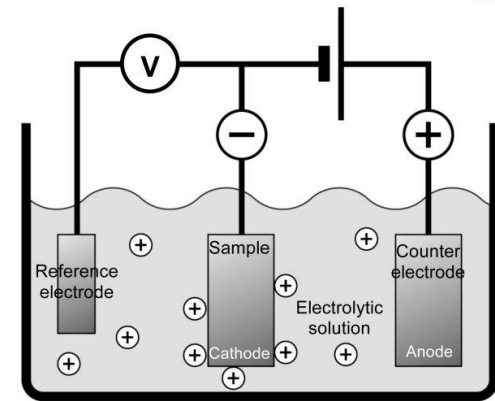
Introduction

- Nb_3Sn phase is industrially produced by high temperature **interdiffusion** of Nb and Sn, with the addition of other metals.
- In the labs of Polytechnic of Milan I have been working to prepare **electrodeposited layers** of **nanocrystalline – amorphous** Nb-Sn alloy with the goal of verifying a number of flux-pinning models.
- One of the specific goals at Milan is to **control grain size and shape growth**.



Introduction

- I have brought from Milan a number of different samples, consisting in a **niobium tape substrate**, with an electrodeposited Sn layer, or Cu-Sn layers of different thickness.
- The work at FNAL has been focused to study the **diffusional behavior** between pure Nb and Sn in these thin films, by performing different **heat treatments**. It was expected that heat treatment cycles would be much **different than for Nb₃Sn wires** [1].



[1] Kinetics of phase growth during the Cu-Sn diffusion process. Optimization of superconducting properties. Sara Mattafirri. FNAL



Experimental procedure

Position the niobium-tin covered tape in a sample holder, which has to be put in a tubular oven in an argon atmosphere to prevent oxidation of the sample, with subsequent performing of different heat treatments.



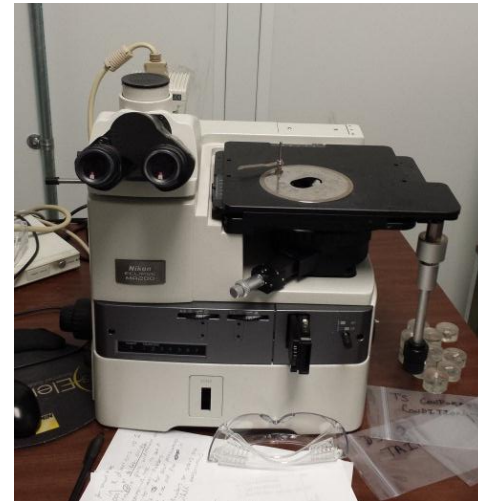
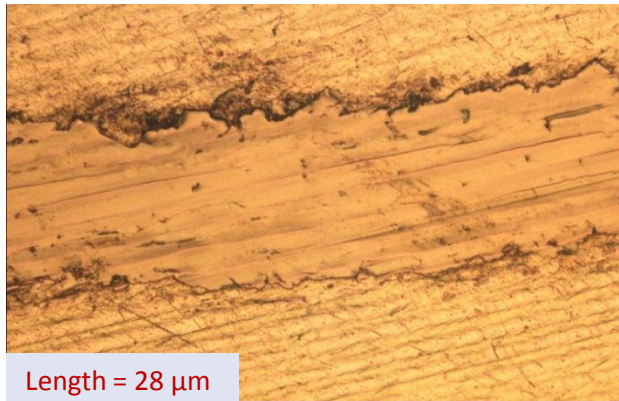
Experimental procedure

- **Extraction** of the sample from the oven and embedding in epoxy resin matrix.
- **Polishing** procedure of the sample, to reduce the average roughness of $\sim 1\mu\text{m}$.



Experimental procedure

- **Optical microscopy** and observation of the sample: measuring of the **thickness** of the new generated phase (10 data points measured for every sample).
- For the **grain radius** measurement a **SEM** is needed



Temperature and time effect on phase growth

- $L = \sqrt{2Dt}$
- L [μm] = thickness of the new phase
- t [s] = heat treatment time
- D [$\mu\text{m}^2 \text{s}^{-1}$] = Diffusion coefficient
- $D = D_0 e^{-\frac{Q}{RT}}$
- Q [J] = activation energy
- T [K] = heat treatment temperature
- D_0 [$\mu\text{m}^2/\text{s}$] = diffusion frequency



[2] *Journal of ELECTRONIC MATERIALS*, Vol. 42, No. 8, 2013

[3] *Cryogenics* 48 (2008) 323–330

[4] Sherron, P.G., *Diffusion in Solids*, McGraw-Hill

[5] *FERMILAB-Conf-02/175-E* Nov. 2002



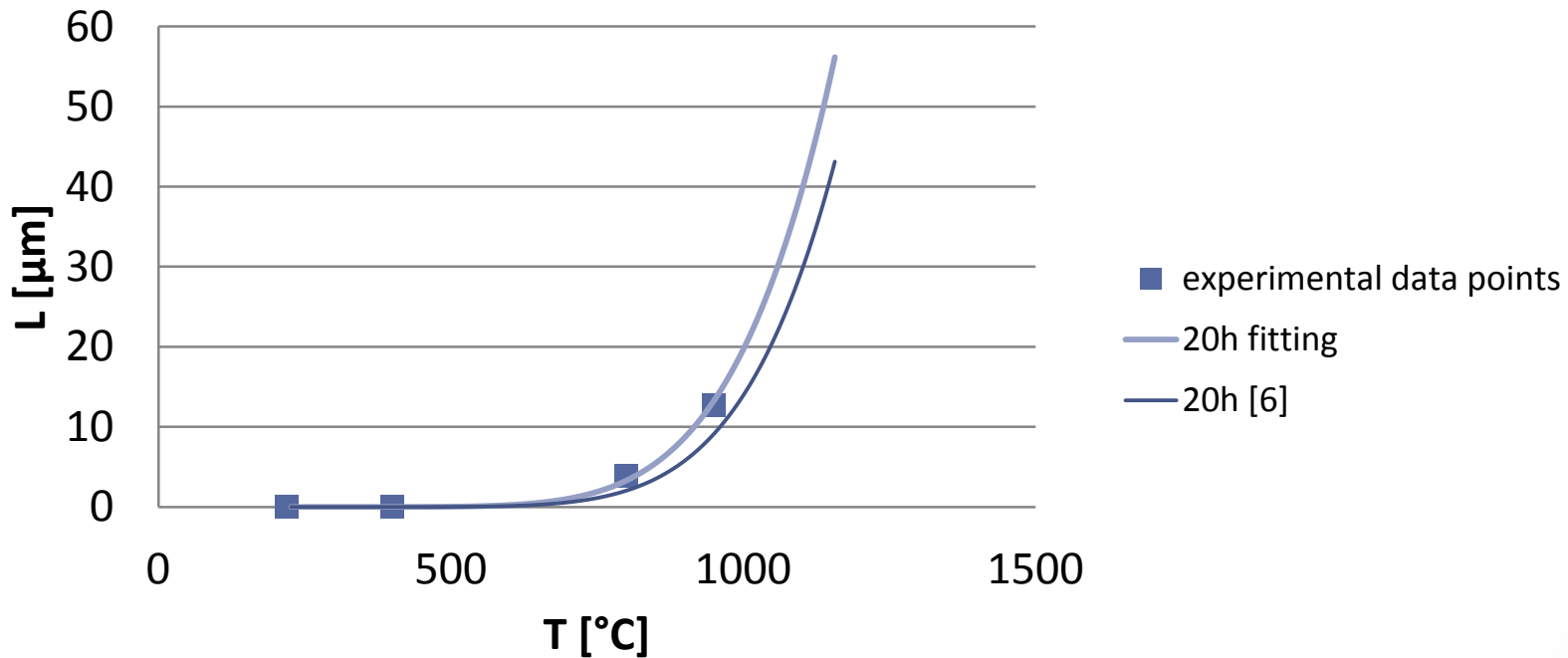
Experimental results

- Literature data give values of $Q = 218 \text{ KJ}$
- Experimental results give values of $Q = 202 \text{ KJ}$ and $D_0 = 2 \cdot 10^9 \text{ } \mu\text{m}^2/\text{s}$. In this case Q is lower, due to the high amount of dislocations that favor diffusive paths.

# sample	Temperature [°C]	Time [h]	Nb ₃ Sn mean phase thickness [μm]	Standard Deviation
1	220	100	-	-
2	400	40	-	-
3	800	40	4.2	0.36
4	800	20	3.9	0.44
5	950	20	12.7	0.48



Nb-Sn exponential diffusion evaluation



Comments and Conclusion

- The **activation energy** for Nb – Sn pure metals is **lower** to that calculated on IT and PIT wires.
- The **diffusion length** in an electrodeposited layer is of the order of **nanometers** (i.e. the dimension of the Nb – Sn metallic grains that have to be homogenized) **instead of $\sim\mu\text{m}$** needed for diffusion in a wire.

Metal phase	Temperature range[°C]	Q [KJ/mol]
CuSn – η	150 - 227	102 [1]
IT	650 - 750	279 [1]
PIT	650 - 750	236 [1]
Nb - Sn	400 - 950	202

[1] Kinetics of phase growth during the Cu-Sn diffusion process. Optimization of superconducting properties. Sara Mattafirri. FNAL



Comments and Conclusion

- For these films the heat treatment for the formation of a stoichiometric A15 phase has to be performed at Temperatures higher than 650°C [7]. As an example, the time to obtain a thickness of 100 nm , using the calculated experimental values at 650°C , is *less than an hour*.
- Production of samples will continue at Milan Polytechnics. They will be heat treated according to the results of this work, before being evaluated for *critical current*.



[7] Performance boundaries in Nb₃Sn superconductors, Arno Godeke

